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Harzlaminate

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Description

BACKGROUND OF THE INVENTION

1. Field of the Invention

The present invention relates to a resin laminate and, more particularly, to a resin laminate which is excellent in heat sealability and suitable for packing liquid, powdery or granular matters such as various foods, beverages or chemicals.

2. Description of Related Art

Heretofore, as packaging materials for liquid, powdery or granular matters, such as various foods, beverages, chemicals, cement, sand or the like, there have been employed paper, synthetic resin sheets or films, a laminated material consisting of paper and synthetic resin sheets or films or the like. Packaging materials made up of synthetic resins, particularly polyolefin sheets or films, are employed in many industrial fields because of their excellent formability, water resistance and chemical resistance as well as their high productivity.

For packaging films for packing various goods such as foods and beverages, a good heat sealability is required. In order for there to be a good heat sealability, for instance, a sealing temperature should be low, a range of sealing temperatures should be wide, a sealing strength should be high, a sealability of foreign matters particularly containing liquid matters should be sufficient, and little or no shrinkage in sealing should occur.

In addition, packaging films require properties which would not interfere with a good heat sealability, such as a good film stability and a high rigidity for convertibility. In summary, good packaging films require properties particularly in a favorable balance of convertibility with heat sealability.

Various attempts have heretofore been made to improve packaging materials in heat sealability, transparency, rigidity or impact resistance.

For example, Japanese Patent Publication (laid-open) No. 12,008/1980 discloses packaging bags made up of a multilayer film consisting of inner and outer layers, in which there is employed as an inner layer a random copolymer having a density of 0.915 to 0.940 g/cm³, obtained by copolymerizing ethylene with an α -olefin having 5 to 10 inclusive carbon atoms in the presence of a catalyst consisting of a titanium catalyst component (containing a titanium compound and a magnesium compound) and an organoaluminium compound in order to provide the inner layer with an improved heat sealability. This publication states that the random copolymer has a density ranging preferably from 0.920 to 0.935 g/cm³, a melt index ranging preferably from 1.0 to 5.0, and a film thickness ranging preferably from 5 to 40 μ m. It further states that, as an outer layer, there may be employed paper, aluminium foil, and a film of a polymer capable of forming a film, such as polyethylene, polypropylene, poly[vinyl chloride], poly[vinylidene chloride], nylon and polyethylene terephthalate. The inner and outer layers are laminated to form a multilayer film, and the both inner layers of the multilayers are heat-sealed to each other to form a packaging bag.

Japanese Patent Publication (laid-open) Nos. 59,943/1982 and 36,549/1985 disclose ethylene- α -olefin copolymers with a good heat sealability as raw materials for laminating. The former discloses a composition comprising a mixture of an ethylene- α -olefin copolymer having a smaller melt index with an ethylene- α -olefin copolymer having a larger melt index, having a wide distribution of the molecular weights, and improving its convertibility. The latter discloses a composition of polymers for heat sealing, which comprises a mixture of an ethylene- α -olefin copolymer with an ethylenic polymer such as a low density or a high density polyethylene.

Japanese Patent Publication (laid-open) No. 160,147/1983 discloses a heat-sealable coextruded multilayer film, in which its inner layer is composed of a layer of an ethylene- α -olefin copolymer having a density ranging from 0.92 to 0.94 g/cm³, its core layer is composed of a layer of a low-density polyethylene having a density ranging from 0.92 to 0.93 g/cm³, manufactured by high-pressure method and its outer layer is composed of a layer of an ethylene- α -olefin copolymer having a density ranging from 0.91 to 0.93 g/cm³.

Japanese Patent Publication (laid-open) No. 54,283/1978 discloses a multilayer film in which an ethylene-vinyl acetate copolymer layer having a lower melting point is laminated on a polyethylene layer having a melting point higher than that of the ethylene-vinyl acetate copolymer and a film thickness from 1 to 10 μ m and the ethylene-vinyl acetate copolymer layer is further laminated on a base film such a nylon layer. Further resin laminates are disclosed in EP-A-050455 and EP-A-0258527.

The ethylene- α -olefin copolymer layers as have been described hereinabove have a good heat sealability, however, they are insufficient to sealability at low temperatures, sealability when with impurities, a range of sealing temperatures or sealing shrinkage. The conventional multilayer films as have been described hereinabove are good in heat sealability, but they are poor in film forming and rigidity as well as inferior in formability, thus leading to insufficient packaging materials. Furthermore, a film containing vinyl acetate may generate an odor and shrink in a large degree during sealing so that it is insufficient in these respects.

SUMMARY OF THE INVENTION

Therefore, the present invention has the object to provide a resin laminate which is superior to sealability at low temperatures, sealability of impurities, and a resistance to pinholes and good in film forming and convertivity. The resin laminate according to the present invention is particularly suitable for packing liquid materials.

In order to achieve the object, the present invention consists of a highly heat-sealable resin laminate comprising:

a heat-sealable layer (A) comprising a linear low density polyethylene (LLDPE) random copolymer obtainable by copolymerizing ethylene with at least an α -olefin having from 4 to 10 inclusive carbon atoms, having a density ranging from 0.900 to 0.920 g/cm³, a melt index ranging from 5 to 50 grams per 10 minutes (190°C), and a thickness ranging from 2 to 15 μ m; with the proviso that a polyolefin rubber is not included in the heat-sealable layer (A); and

a polyolefinic resin layer (B) having a tensile modulus of 4,000 kg/cm² or higher and a melting point higher than that of the heat-sealable layer (A),

wherein the heat-sealable layer (A) is laminated on the polyolefinic resin layer (B), wherein the heat-sealable layer (B) is further laminated on a base film (C), comprising single layer or multiple layers of nylon, polyester, polyvinylalcohol, polypropylene, polycarbonate film, aluminium foil or other metallic foil, or paper.

A further embodiment is a resin laminate comprising:

a heat-sealable layer (A) comprising a mixture containing 70% by weight or more with respect to the total weight of the heat-sealable layer (A) of a linear low density polyethylene (LLDPE) random copolymer obtainable by copolymerizing ethylene with at least an α -olefin having from 4 to 10 inclusive carbon atoms and 30% by weight or less of a low-crystallinity ethylene-butene-1 copolymer, having a density ranging from 0.900 to 0.920 g/cm³, a melt index ranging from 5 to 50 grams per 10 minutes (190 °C), and a thickness ranging from 2 to 15 μ m; and

a polyolefinic resin layer (B) having a tensile modulus of 4,000 kg/cm² or higher and a melting point higher than that of the heat-sealable layer (A),

wherein the heat-sealable layer (A) is laminated on the polyolefinic resin layer (B), wherein the heat-sealable layer (B) is further laminated on a base film (C), comprising single layer or multiple layers of nylon, polyester, polyvinylalcohol, polypropylene, polycarbonate film, aluminium foil or other metallic foil, or paper.

FIGURE 1 is a cross-sectional view showing one example of the resin laminate according to the present invention.

The resin laminate according to the present invention will be described more in detail.

The heat-sealable layer (A) is composed of a layer of a random copolymer obtainable by copolymerizing ethylene with an α -olefin having from 4 to 10 inclusive carbon atoms. Such an α -olefin may include, for example, butene-1, pentene-1, hexene-1, 4-methylpentene-1, octene-1, nonene-1 or decene-1. The α -olefin as a comonomer unit of the random copolymer may be used singly or in combination thereof.

In accordance with the present invention, the random copolymer having the density and melt index within the specified ranges is a linear low density polyethylene (LLDPE) containing an α -olefin unit as defined in claims 1 and 2.

The heat-sealable layer (A) may additionally contain a low-crystallinity ethylene-butene-1 copolymer as defined in claim 2.

The heat-sealable layer (A) has a density ranging generally from 0.900 to 0.920 g/cm³, preferably from 0.900 to 0.915 g/cm³, and a melt index ranging generally from 5 to 50 grams per 10 minutes (190°C), preferably from 6 to 20 grams per 10 minutes (190°C).

If the heat-sealable layer (A) has a density below the lower limit of 0.900 g/cm³, rigidity and heat sealability of a laminated film may be reduced, while the heat-sealable layer (A) having a density above the upper limit of 0.920 g/cm³ makes the resulting laminated film poor in heat sealability at low temperatures and an impact strength. If the heat-sealable layer (A) has a melt index smaller than the lower limit of 5 g/10 minutes, its melt viscosity becomes too large and formability is impaired and, if it has a melt index larger than the upper limit of 50 g/10 minutes, a strength between the heat-sealed portion of the resulting film becomes too weak, thereby reducing a film strength. It is further to be noted that, although a melt index for a usual film grade is lower than 4 g/10 minutes(190°C), the heat-sealable layer (A) having a melt index larger than 4 g/ 10 minutes(190 °C) is of note to be used for the resin laminate according to the present invention. A provision of the heat-sealable (A) having a melt index larger than the usual film grade serves as achieving the object of the present invention.

A film thickness of the heat-sealable layer (A) ranges from 2 to 15 μ m, preferably from 2 to 10 μ m. The heat-sealable layer (A) having a film thickness thinner than the lower limit becomes poor in film forming while a film thickness larger than the upper limit may cause shrinkage during sealing.

It is further preferred that the heat-sealable layer (A) has a tensile modulus ranging preferably from 1,000 to 4,000

kg/cm². The heat-sealable layer (A) having a tensile modulus below the lower limit 1,000 kg/cm² makes a film strength weaker, while the heat-sealable layer (A) having a tensile modulus greater than the upper limit 4,000 kg/cm² may adversely affect its heat sealability.

The polyolefinic resin layer (B) is composed of a layer of a polyolefin resin which may include, for example, a polyethylene such as a high density polyethylene, middle density polyethylene, low density polyethylene or linear low density polyethylene, a polypropylene such as an isotactic polypropylene, syndiotactic polypropylene or atactic polypropylene, a polybutene, or poly-4-methylpentene-1. A copolymer of an olefin with a vinyl monomer may be used which may include, for example, ethylene-propylene copolymer, ethylene-vinyl acetate copolymer, ethylene-vinyl chloride copolymer or propylene-vinyl chloride copolymer. As polyolefines may be used the polyolefins which are chemically denatured by an unsaturated carboxylic acid or an anhydride thereof or a derivative thereof. Preferred are a high density polyethylene, a linear low density polyethylene (LLDPE), a polypropylene, polybutene-1 and poly-4-methylpentene-1, each having a density of 0.920 g/cm³ or higher.

The polyolefinic resin layer (B) has a tensile modulus of 4,000 kg/cm² or higher, preferably from 4,000 to 12,000 kg/cm². If its tensile modulus becomes smaller than the lower limit of 4,000 kg/cm², a film strength of the resulting film becomes smaller. If it exceeds the upper limit of 12,000 kg/cm², its heat sealability may become poor.

The heat-sealable layer (A) and the polyolefinic resin layer (B) may additionally contain a variety of additives as long as they do not adversely affect the object sought to be achieved by the present invention. The additives may include, for example, a lesser soluble soluble azo dye, a red colorant, a colorant such as cadmium yellow, chrome yellow, white titanium pigment, an antioxidant such as of a triazole, salicylate, or acrylonitrile type, a plasticizer such as phthalate diester, butanol diester or phosphate diester and a thermal stabilizer.

It is further to be noted that a melting point of the polyolefinic resin (B) be higher than the heat-sealable layer (A) having 4,000 kg/cm², preferably 4,000 to 12,000 kg/cm². A difference of the melting point of the polyolefinic resin (B) from that of the heat-sealable layer (A) may vary with the composition of the heat-sealable layer (A). The melting point of the polyolefinic resin layer (B) may range generally from 120°C to 160 °C.

The polyolefinic resin layer (B) may have a film thickness ranging generally from 5 to 200 μm, preferably from 10 to 100μm.

The resin laminate according to the present invention may be prepared by coextruding the heat-sealable layer (A) with the polyolefinic layer (B) by means of T-die extrusion forming, inflation extrusion forming or the like at a resin temperature ranging from 180 °C to 300 °C and cooling the laminated material by means of chill rolls at a temperature of 20 °C to 80°C. In laminating the heat-sealable layer (A) on the polyolefinic layer (B), it is preferred that a surface of the polyolefinic layer (B) to be laminated is surface-treated by means of surface oxidation treatment such as corona discharge treatment, chromate treatment, flame treating, hot-air treating, treatment with ozone or ultraviolet rays or the like, or surface abrasion treatment such as sand blasting. Preferred is corona discharge treatment.

The resin laminates according to the present invention comprise a three-layer laminate in which a base film (C) is laminated on a surface of the polyolefinic resin layer (B) opposite to the surface thereof on which the heat-sealable layer is laminated. The base film (C) includes a nylon such as nylon-6, a polyester such as polyethylene terephthalate, a polyvinyl alcohol such as a saponified ethylene-vinyl acetate copolymer, a oriented or non-oriented film or sheet of polypropylene, polycarbonate film, aluminium foil or other metallic foil, or paper. The base film may be of a single layer or multiple layers. It may vary with usage of the resin laminates, however, it may have a film thickness generally from 10 to 100μm.

The multilayer resin laminates according to the present invention may be prepared by means of any laminating procedures forming a laminated structure in a film or sheet, such as coextrusion laminating, dry laminating, hot laminating, hot melt laminating or extrusion laminating. During lamination of the base film (C) on the polyolefinic resin layer (B), it is preferred to subject a laminating surface thereof to surface treatment as have been described hereinabove, particularly corona discharge treatment.

The base film (C) serves as providing the resin laminate with an improved mechanical strength such as rigidity and the heat-sealable layer (A) containing the random copolymer is excellent in heat sealability. Thus the packaging bags formed from the laminates are suitable for packing granular or liquid matters such as food, beverages, cement or sand.

The present invention provides resin laminates which are excellent in sealability at low temperatures, sealability having impurities and sealing for filling liquid matter and which little shrink in sealing. The heat-sealed products give a favorable outlook of a heat-sealed portion without pinholes, a high sealing strength, and a good impact strength. The resin laminates according to the present invention are remarkably favorable in film forming, laminating, printability, and forming into packaging materials although they are highly sealable at low temperatures. Thus the resin laminates according to the present invention can be employed effectively for a sealant for multilayer films as packaging materials and for packing various matters as packaging bags.

The present invention will be described by way of examples.

Example 1:

Using a resin as shown in Table 1 below, there was formed a resin laminate having a heat-sealable layer (A) and a polyolefinic resin layer (B) in the following manner.

The heat-sealable layer (A) and the polyolefinic resin layer (B) were each molten and extruded through an extruder having a 50mm nozzle and a 65 mm nozzle, respectively, to a multi-manifold multilayer T-die (a die width: 800 mm) which, in turn, coextruded at the die temperature of 250 °C and cooled by means of chill rolls at 40 °C, thereby forming a multilayer film comprising the heat-sealable layer (A) having a film thickness of 7 µm and the polyolefinic resin layer (B) having a film thickness of 43 µm.

The multilayer film was measured for its tensile modulus and sealing temperature. The results are shown in Table 2 below. It is noted herein that the sealing temperature was measured as its heat-sealing strength has amounted to 300 grams per 15mm in substantially the same manner as will be described below as "Idemitsu Test Method".

The multilayer film thus obtained was then laminated on a oriented nylon film (C) with 15 µm thickness, yielding a laminated film. The resulting resin laminate has a structure as shown in FIGURE 1, in which reference numeral 1 denotes the heat-sealable layer (A) containing the ethylene- α -olefin random copolymer, reference numeral 2 denotes the polyolefinic resin layer (B), and reference numeral 3 denotes the base film (C).

The properties of the laminated film are shown in Table 2 below.

Example 2:

A heat-sealable layer (A) containing the random copolymer as shown in Table 1 above and the polyolefinic resin layer (B) were laminated in the same manner as in Example 1 to give a multilayer film.

A surface of the polyolefinic resin layer (B) of the resulting multilayer film was then subjected to corona discharge treatment at 28W/m²/minute. The surface of the polyolefinic resin layer (B) was coated with an adhesive and then laminated in dry manner with a oriented nylon film (C) having a film thickness of 15µm, thereby producing a laminated film. The resulting laminated film has a three-layer structure as shown in FIGURE.

The properties of the resulting laminated film are shown in Table 2 below.

Example 3:

A heat-sealable layer (A) containing the random copolymer as shown in Table 1 below and the polyolefinic resin layer (B) were laminated in the same manner as in Example 1 to give a multilayer film.

The multilayer film was measured for its tensile modulus and sealing temperature. The results are shown in Table 2 below. It is noted herein that the sealing temperature was measured as its heat-sealing strength has amounted to 300 grams per 15mm in substantially the same manner as will be described below as "Idemitsu Test Method".

The multilayer film was then laminated on a oriented nylon film (C) to give a laminated film as shown in FIGURE 1. The properties of the laminated film are shown in Table 2 below.

Comparative Examples 1 - 5:

In the same manner as in Examples 1 to 3, a heat-sealable layer (A) containing the resin as shown in Table 1 below was laminated on the polyolefinic resin layer by coextrusion, thus yielding a multilayer film which, in turn, was laminated on a oriented nylon film (C) so as to bring the polyolefinic resin layer to come in contact with the nylon film (C) in the same manner as in Examples 1 to 3, thereby giving a laminated film.

In Comparative Examples 1 and 4, the resulting multilayer film was measured for its tensile strength and sealing temperature. The sealing temperature was measured in accordance with the "Idemitsu Test Method" as will be described hereinbelow. The results are shown in Table 2 below.

In Comparative Examples 2, 3 and 5, the resulting multilayer film was then laminated on a drawn nylon film (C), yielding a laminated film. The properties of the laminated film are shown in Table 2 below.

As will be apparent from Table 2 below, the resin laminates obtained in Examples 1 to 3 have a sealing temperature lower than, a range of sealing temperatures wider than, and a sealing shrinkage smaller than those obtained in Comparative Examples 1 to 5.

Evaluation Procedures:

The multilayer film having a two-layer structure consisting of the heat-sealable layer (A) and the polyolefinic resin layer (B) as well as the laminated film having at least three layers containing the base film (C) in addition to the above two layers have been evaluated for their properties by the following procedures:

*1. Sealing Temperature (Idemitsu Test Method):

One sheet of the multilayer film was laminated on another sheet of the multilayer film such that their respective heat-sealable layers (A) were heat-sealed at a pressure of 2 kg/cm² over the period of 1 second. The sealing temperature was measured using a heat gradient tester (Toyo Seiki K. K.) as the temperature when a heat-sealing strength between the respective heat-sealable layers (A) reached 2,000 grams per 15 mm.

*2. Sealability of Foreign Matter (I):

When salad oil was filled as foreign matter, the sealing temperature was measured in substantially the same conditions as above.

*3. Sealability of Foreign Matter (II):

When soy sauce was filled as foreign matter, the sealing temperature was measured in substantially the same conditions as above.

*4. Range of Sealing Temperatures for Filling:

A packaging bag (60 mm x 70 mm) was filled with soy sauce at the filling rate of 80 bags per minute in a single roll system using a filling packer (half-folding, three-sided sealing filler: Model "KS 324"; Komatsu Seisakusho K.K.). To the bag filled with soy sauce was then applied a load of 100 kg, and a range of sealing temperatures was measured at which the sealing temperatures can endure the load of 100 kg for five minutes or longer.

*5. Sealing Shrinkage:

The multilayer films were laminated at the sealing temperature of 145 °C at the above filling conditions to give a packaging bag. The sealing shrinkage was calibrated as follows:

$$\text{Sealing Shrinkage (\%)} = \frac{\text{Thickness of Sealed Portion}}{\text{Total thickness of laminate}} \times 100$$

TABLE 1

RESINS		Density g/cm ³	Melt Index g/10min, (190°C)	Tensile Strength kg/cm ²	Melting Point (°C)
LLDEP 1	Ethylene- α -olefin copolymer (Idemitsu Sekiyu Kagaku) MORETEC 1018C (C8)	0.905	9	2,100	118
LLDEP 2	- do. -MORETEC 0258C (C8)	0.930	2	6,400	125
LLDEP 3	- do. -MORETEC 0238C (C8)	0.920	2	4,300	122
HDPE	High Density Polyethylene (Idemitsu Sekiyu Kagaku) IDEMITSU POLYETHY 440M	0.954	0.9	11,000	131
EBC *1	Ethylene-butene-1 copolymer ¹⁾	0.88	4		70
EVA *2	Ethylene-vinyl acetate copolymer	0.927	3		96

* 1 : Mooney viscosity M L₁₊₄ = 18 (100 °C)

* 2 : Content of vinyl acetate unit is 7 wt% in the copolymer.

(R O L L S T O C K H I C K N E S S 50 μm , (A) / (B) = 7/43 μm)				MULTILAYER FILM				LAMINATED FILM (ORIENTED NYLON/MULTILAYER FILM - 15/50 μm)					
COMPOSITION (% BY WT)		ROLLSTOCK PROPERTIES		PRACTICAL PROPERTIES			IN-IMPURITIES PROPERTIES			REMARKS			
LAYER A	LAYER B	TENSILE MODULUS (Kg/ cm^2)	SEALING TEMP. ($^{\circ}\text{C}$)	* 1 SEALING TEMP. ($^{\circ}\text{C}$)	* 2 SEALABILITY IN-IMPURITIES (I) ($^{\circ}\text{C}$)	* 3 SEALABILITY IN-IMPURITIES (II) ($^{\circ}\text{C}$)	* 4 RANGE OF SEALING TEMP. FOR FILG ($^{\circ}\text{C}$)	* 5 SEALING SHRINKAGE (%)					
EX. 1	LLDPE 1	LLDPE 2	4500	97	100	114	117	125~150	95	DRY LAMINATED FILM			
EX. 2	LLDPE 1, (80) EBC, (20)	LLDPE 2	4300	92	95	110	113	120~150	80	DRY LAMINATED FILM			
EX. 3	LLDPE 1, (90) EBC (10)	HDPE	8500	95	98	112	115	123~150	90	DRY LAMINATED FILM			
CO. EX. 1	LLDPE 2	LLDPE 3	2200	122	125	135	138	145~150	90	DRY LAMINATED FILM			
CO. EX. 2	LLDPE 2	LLDPE 2	5000	123	126	135	138	145~150	90	DRY LAMINATED FILM			
CO. EX. 3	LLDPE 3	LLDPE 3	1800	106	110	120	130	140~150	70	DRY LAMINATED FILM			
CO. EX. 4	LLDPE 2	HDPE	9000	125	128	137	139	145~150	90	DRY LAMINATED FILM			
CO. EX. 5	EVA	EVA	1500	94	98	120	125	145~160	45	DRY LAMINATED FILM			

Claims

1. A resin laminate comprising:

a heat-sealable layer (A) comprising a linear low density polyethylene (LLDPE) random copolymer obtainable by copolymerizing ethylene with at least an α -olefin having from 4 to 10 inclusive carbon atoms, having a density ranging from 0.900 to 0.920 g/cm³, a melt index ranging from 5 to 50 grams per 10 minutes (190°C), and a thickness ranging from 2 to 15 μ m; with the proviso that a polyolefin rubber is not included in the heat-sealable layer (A); and

a polyolefinic resin layer (B) having a tensile modulus of 4,000 kg/cm² or higher and a melting point higher than that of the heat-sealable layer (A),

wherein the heat-sealable layer (A) is laminated on the polyolefinic resin layer (B), wherein the heat-sealable layer (B) is further laminated on a base film (C), comprising single layer or multiple layers of nylon, polyester, polyvinylalcohol, polypropylene, polycarbonate film, aluminium foil or other metallic foil, or paper.

2. A resin laminate comprising:

a heat-sealable layer (A) comprising a mixture containing 70% by weight or more with respect to the total weight of the heat-sealable layer (A) of a linear low density polyethylene (LLDPE) random copolymer obtainable by copolymerizing ethylene with at least an α -olefin having from 4 to 10 inclusive carbon atoms and 30% by weight or less of a low-crystallinity ethylene-butene-1 copolymer, having a density ranging from 0.900 to 0.920 g/cm³, a melt index ranging from 5 to 50 grams per 10 minutes (190 °C), and a thickness ranging from 2 to 15 μ m; and

a polyolefinic resin layer (B) having a tensile modulus of 4,000 kg/cm² or higher and a melting point higher than that of the heat-sealable layer (A),

wherein the heat-sealable layer (A) is laminated on the polyolefinic resin layer (B), wherein the heat-sealable layer (B) is further laminated on a base film (C), comprising single layer or multiple layers of nylon, polyester, polyvinylalcohol, polypropylene, polycarbonate film, aluminium foil or other metallic foil, or paper.

3. A resin laminate as claimed in claim 1 or 2, wherein the heat-sealable layer (A) has a film thickness ranging from 2 to 10 μ m.

4. A resin laminate as claimed in claim 1 or 2, wherein the polyolefinic resin layer (B) has a film thickness ranging from 5 to 200 μ m.

5. A resin laminate as claimed in claim 1 or 2, wherein the polyolefinic resin layer (B) has a film thickness ranging from 10 to 100 μ m.

6. A resin laminate as claimed in claim 1 or 2, wherein the base film has a film thickness ranging from 10 to 100 μ m.

Patentansprüche

1. Harzlaminat, umfassend

eine heißsiegefähige Schicht (A), umfassend ein statistisches Copolymer eines linearen Hochdruck-Polyethylens (LLDPE), erhältlich durch Copolymerisieren von Ethylen mit mindestens einem α -Olefin mit 4 bis einschließlich 10 Kohlenstoffatomen, die eine Dichte im Bereich von 0,900 bis 0,920 g/cm³, einen Schmelzindex im Bereich von 5 bis 50 g pro 10 Minuten (190°C) und eine Dicke im Bereich von 2 bis 15 μ m aufweist; mit der Maßgabe, daß die heißsiegefähige Schicht (A) keinen Polyolefinkautschuk beinhaltet; und eine polyolefinische Harzschicht (B) mit einem Zugmodul von 4000 kg/cm² oder höher und einem höherem Schmelzpunkt als dem der heißsiegefähigen Schicht (A),

wobei die heißsiegefähige Schicht (A) auf der polyolefinischen Harzschicht (B) laminiert ist, wobei die heißsiegefähige Schicht (B) weiterhin auf einer Grundfolie (C) laminiert ist, die eine Einzelschicht oder Mehrschichten aus Nylon, Polyester, Polyvinylalkohol, Polypropylen, Polycarbonatfolie, Aluminiumfolie oder andere metallische Folie oder Papier umfaßt.

2. Harzlaminat, umfassend

eine heißsiegelfähige Schicht (A), umfassend eine Mischung, enthaltend 70 Gew.-% oder mehr, bezogen auf das Gesamtgewicht der heißsiegelfähigen Schicht (A), eines statistischen Copolymeren eines linearen Hochdruck-Polyethylens (LLDPE), erhältlich durch Copolymerisieren von Ethylen mit mindestens einem α -Olefin mit 4 bis einschließlich 10 Kohlenstoffatomen, und 30 Gew.-% oder weniger eines niederkristallinen Ethylen-Buten-1-Copolymeren, welche eine Dichte im Bereich von 0,900 bis 0,920 g/cm³, einen Schmelzindex im Bereich von 5 bis 50 g pro 10 Minuten (190°C) und eine Dicke im Bereich von 2 bis 15 μ m aufweist; und eine polyolefinische Harzschicht (B) mit einem Zugmodul von 4000 kg/cm² oder höher und einem höheren Schmelzpunkt als dem der heißsiegelfähigen Schicht (A),

wobei die heißsiegelfähige Schicht (A) auf der polyolefinischen Harzschicht (B) laminiert ist, wobei die heißsiegelfähige Schicht (B) weiterhin auf einer Grundfolie (C) laminiert ist, die eine Einzelschicht oder Mehrschichten aus Nylon, Polyester, Polyvinylalkohol, Polypropylen, Polycarbonatfolie, Aluminiumfolie oder andere Metallfolie oder Papier umfaßt.

3. Harzlaminat nach Anspruch 1 oder 2, wobei die heißsiegelfähige Schicht (A) eine Schichtdicke im Bereich von 2 bis 10 μ m aufweist.

4. Harzlaminat nach Anspruch 1 oder 2, wobei die polyolefinische Harzschicht (B) eine Schichtdicke im Bereich von 5 bis 200 μ m aufweist.

5. Harzlaminat nach Anspruch 1 oder 2, wobei die polyolefinische Harzschicht (B) eine Schichtdicke im Bereich von 10 bis 100 μ m aufweist.

6. Harzlaminat nach Anspruch 1 oder 2, wobei die Grundfolie eine Schichtdicke im Bereich von 10 bis 100 μ m aufweist.

Revendications

1. Stratifié de résine comprenant :

une couche soudable à chaud (A) comprenant un copolymère statistique de polyéthylène linéaire basse densité (PELBD) que l'on peut obtenir par copolymérisation d'éthylène avec au moins une α -oléfine comportant de 4 à 10 (inclus) atomes de carbone, ayant une masse volumique comprise entre 0,900 et 0,920 g/cm³, un indice de fusion compris entre 5 et 50 grammes pour 10 minutes (190°C) et une épaisseur comprise entre 2 et 15 μ m; sous réserve qu'un caoutchouc polyoléfinique ne soit pas inclus dans la couche soudable à chaud (A); et

une couche de résine polyoléfinique (B) ayant un module de traction de 4 000 kg/cm² ou plus, et un point de fusion supérieur à celui de la couche soudable à chaud (A),

la couche soudable à chaud (A) étant stratifiée sur la couche de résine polyoléfinique (B), la couche soudable à chaud (B) étant en outre stratifiée sur un film de base (C), comprenant une couche unique ou des couches multiples de nylon, de polyester, d'alcool polyvinylique, de polypropylène, de film en polycarbonate, de feuille d'aluminium ou autre feuille métallique, ou de papier.

2. Stratifié de résine comprenant :

une couche soudable à chaud (A) comprenant un mélange contenant 70 % en poids ou plus, par rapport au poids total de la couche soudable à chaud (A), d'un copolymère statistique de polyéthylène linéaire basse densité (PELBD), que l'on peut obtenir par copolymérisation d'éthylène avec au moins une α -oléfine comportant de 4 à 10 (inclus) atomes de carbone, et 30 % en poids ou moins d'un copolymère éthylène-butène-1 de faible cristallinité, ayant une masse volumique comprise entre 0,900 et 0,920 g/cm³, un indice de fusion compris entre 5 et 50 grammes pour 10 minutes (190°C) et une épaisseur comprise entre 2 et 15 μ m; et une couche de résine polyoléfinique (B) ayant un module de traction de 4 000 kg/cm² ou plus, et un point de fusion supérieur à celui de la couche soudable à chaud (A),

la couche soudable à chaud (A) étant stratifiée sur la couche de résine polyoléfinique (B), la couche soudable à chaud (B) étant en outre stratifiée sur un film de base (C), comprenant une couche unique ou des couches multiples de nylon, de polyester, d'alcool polyvinylique, de polypropylène, de film en polycarbonate, de feuille d'aluminium ou autre feuille métallique, ou de papier.

3. Stratifié de résine selon la revendication 1 ou 2, dans lequel la couche soudable à chaud (A) a une épaisseur de

film comprise entre 2 et 10 μm .

4. Stratifié de résine selon la revendication 1 ou 2, dans lequel la couche de résine polyoléfinique (B) a une épaisseur de film comprise entre 5 et 200 μm .

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5. Stratifié de résine selon la revendication 1 ou 2, dans lequel la couche de résine polyoléfinique (B) a une épaisseur de film comprise entre 10 et 100 μm .

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6. Stratifié de résine selon la revendication 1 ou 2, dans lequel le film de base a une épaisseur de film comprise entre 10 et 100 μm .

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Fig. 1

